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ET U.S. DEPARTMENT OF COMMERCE
U.S. Patent and Trademark Office
Docket No. 740107-144

101815514

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Horohiko IZUMI
Satomi MICHIIYA
Takashi FUJITA
Minoru NUMOTO
Mikhail TUZOV
Additional name(s) of conveying party(ies) attached? Yes No

07/05/01

2. Name and address of receiving party(ies)
Name: Tokyo Seimitsu Co., Ltd.
Internal Address: _____
Street Address: 7-1, Shimorenjaku 9-chome
City: Mitaka-shi State: Tokyo Zip: _____
Country: Japan Postal Code: _____
Additional name(s) & address(es) attached? Yes No

U.S. PTP
09/898090
07/05/01

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: June 25, 2001, June 25, 2001, June 25, 2001, June 25, 2001 and June 25, 2001

4. Application number(s) or patent number(s); 09898090
If this document is being filed together with a new application, the execution date of the application is: June 25, 2001, June 25, 2001, June 25, 2001, June 25, 2001 and June 25, 2001

A. Patent Application No.(s)

B. Patent No.(s)

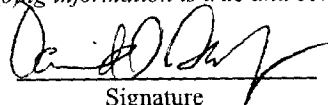
Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:
Name: David S. Safran, Esq.
Internal Address: Nixon Peabody LLP
Street Address: 8180 Greensboro Drive.
Suite 800
City: McLean State: VA Zip: 22102

6. Total number of applications and patents involved: 1
7. Total fee (37 CFR 3.41)..... \$40.00
 Enclosed
 Authorized to be charged to deposit account

8. Deposit account number:
19-2380(740107-144)
(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.
David S. Safran  July 5, 2001
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and documents: 3

Mail documents to be recorded with required cover sheet information to:

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07/09/2001 HDMESS1 00000032 09898090

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ASSIGNMENT

For good and valuable consideration, the sufficiency and receipt of which is hereby acknowledged, as a below named inventor, I hereby sell and assign to Tokyo Seimitsu Co., Ltd. of 7-1, Shimorenjaku 9-chome, Mitaka-shi, Tokyo, Japan

its successors and assigns or other legal representatives all my rights, title and interest, in and for the United States of America, in and to

WAFER POLISHING APPARATUS

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefore, executed on even date herewith and all United States Letters Patent which may be granted therefore, and all divisions, continuations, reissues, reexaminations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Tokyo Seimitsu Co., Ltd. its successors, assigns or other legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Tokyo Seimitsu Co., Ltd.

1. Date 6/25/2001 Inventor Hirohiko IZUMI (Full Name) (Signature) 泉 宏比古
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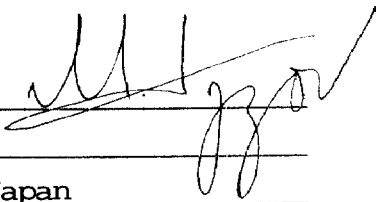
2. Date 6/25/2001 Inventor Satomi MICHIIYA (Full Name) (Signature) 道谷 里美
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Witness(es)

(All) _____ 1) _____ 2) _____
3) _____ 4) _____

5. Date 6/25/2001 Inventor МИХАИЛ ТУЗОВ 14-1/7 
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Witness(es)

(All) _____ 1) Keizo Matsun 2) _____
3) _____ 4) _____